

STP75N75F4

N-channel 75 V, 0.0092 Ω typ., 78 A STripFET™ DeepGATE™ Power MOSFET in a TO-220 package

Datasheet — production data

Features

Туре	V _{DSS}	R _{DS(on)} max	I _D
STP75N75F4	75 V	< 0.011 Ω	78 A

- N-channel enhancement mode
- 100% avalanched rated
- Low gate charge
- Very low on-resistance

Applications

Switching applications

Description

This device is an N-channel Power MOSFET developed using ST's STripFET[™] DeepGATE[™] technology. The device has a new gate structure and is specially designed to minimize on-state resistance to provide superior switching performance.

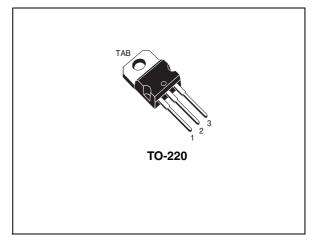


Figure 1. Internal schematic diagram

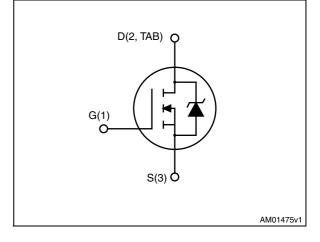


Table 1.Device summary

Order codes	Marking	Package	Packaging
STP75N75F4 75N75F4		TO-220	Tube

This is information on a product in full production.

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1 Electrical ratings

Table 2.	Absolute	maximum	ratings
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Symbol	Parameter	Value	Unit
V_{DS}	Drain-source voltage	75	V
V _{GS}	Gate-source voltage	± 20	V
۱ _D	Drain current (continuous) at T _C = 25 °C	78	А
۱ _D	Drain current (continuous) at T _C = 100 °C	55	А
I _{DM} ⁽¹⁾	Drain current (pulsed)	312	А
P _{TOT}	Total dissipation at $T_{C} = 25 \text{ °C}$	150	W
	Derating factor	1	W/°C
E _{AS} ⁽²⁾	Single pulse avalanche energy	185	mJ
T _{stg}	Storage temperature	55 to 175	°C
Тj	Operating junction temperature	— 55 to 175	

1. Pulse width limited by safe operating area

2. Starting $T_i = 25 \text{ °C}$, $I_D = 35 \text{ A}$, $V_{DD} = 50 \text{ V}$

Table 3.Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case max	1	°C/W
R _{thj-a}	Thermal resistance junction-ambient max	62.5	°C/W



2 Electrical characteristics

(T_{CASE} = 25 °C unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source Breakdown voltage	$I_{D} = 250 \ \mu A, \ V_{GS} = 0$	75			v
I _{DSS}	Zero gate voltage	V _{DS} = 75 V			1	μA
USS	Drain current (V _{GS} = 0)	V _{DS} = 75 V,T _C =125 °C			100	μA
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	$V_{GS} = \pm 20 V$			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	2		4	V
R _{DS(on)}	Static drain-source on- resistance	V_{GS} = 10 V, I _D = 39 A		0.0092	0.011	Ω

Table 4. On/off states

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance			5015		pF
C _{oss}	Output capacitance	V _{DS} = 25 V, f = 1 MHz,	-	382	-	pF
C _{rss}	Reverse transfer capacitance	V _{GS} = 0		218		pF
Qg	Total gate charge	V _{DD} = 37.5 V, I _D = 78 A,		76		nC
Q _{gs}	Gate-source charge	V _{GS} = 10 V	-	23	-	nC
Q _{gd}	Gate-drain charge	(see Figure 14)		18.5		nC

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r	Turn-on delay time Rise time	V _{DD} = 37.5 V, I _D = 39 A R _G = 4.7 ΩV _{GS} = 10 V	-	25 33	-	ns ns
t _{d(off)} t _f	Turn-off-delay time Fall time	(see Figure 13)	-	61 14	-	ns ns



Symbol	Parameter	Test conditions	Min.	Тур.	Max	Unit
I _{SD}	Source-drain current		-		78	А
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		312	А
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} = 78 A, V _{GS} = 0	-		1.5	V
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD} = 78 \text{ A}, V_{DD} = 60 \text{ V}$ di/dt = 100 A/ μ s, T _j = 150 °C (see Figure 15)	-	67 183 5.5		ns nC A

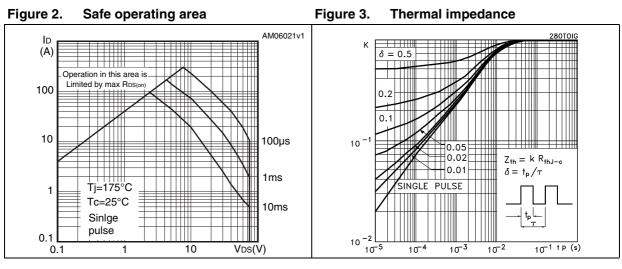
Table 7.Source drain diode

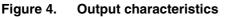
1. Pulse width limited by safe operating area.

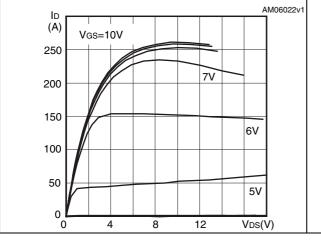
2. Pulsed: Pulse duration = 300 μ s, duty cycle 1.5%



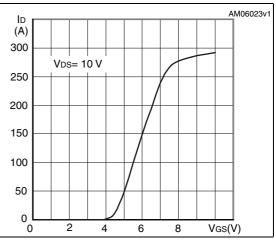
2.1 Electrical characteristics (curves)













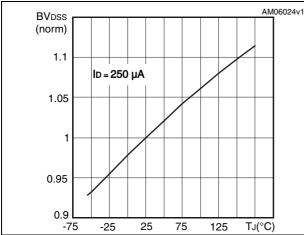
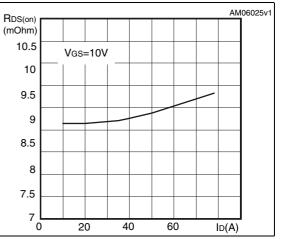


Figure 7. Static drain-source on-resistance



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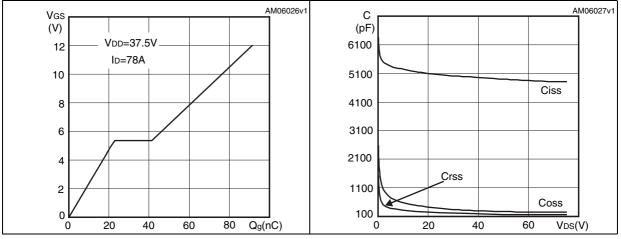
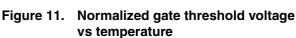


Figure 8. Gate charge vs gate-source voltage Figure 9. Capacitance variations

Figure 10. Normalized on-resistance vs temperature



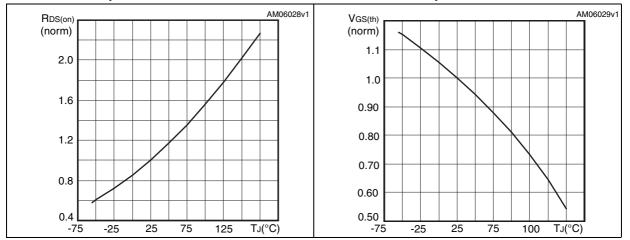
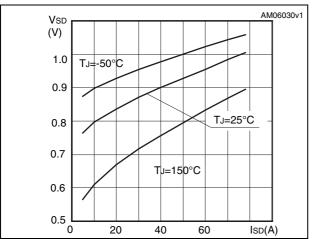


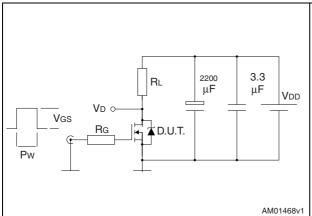
Figure 12. Source-drain diode forward characteristics





3 Test circuits

Figure 13. Switching times test circuit for resistive load



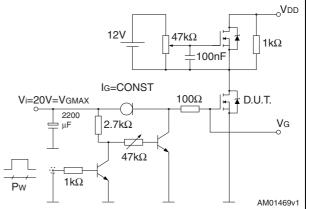
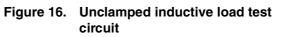
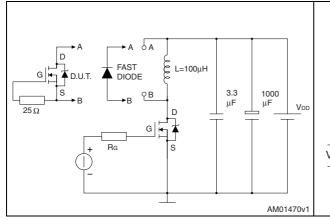
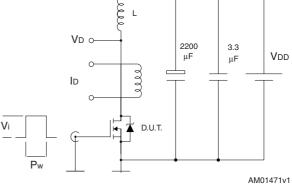


Figure 14. Gate charge test circuit

Figure 15. Test circuit for inductive load switching and diode recovery times







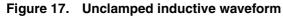
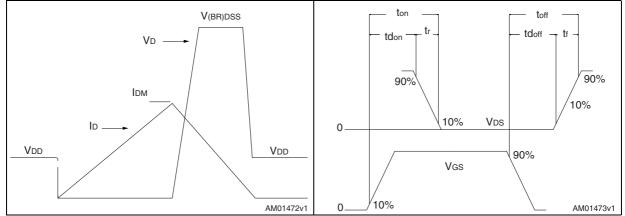


Figure 18. Switching time waveform



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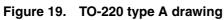
4 Package mechanical data

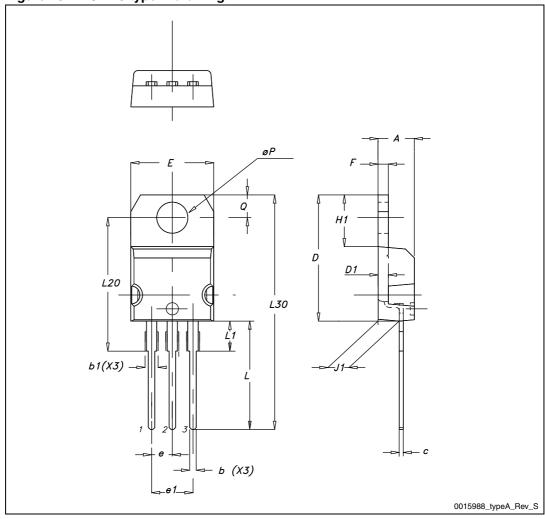
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Dim	<i>,</i> ,	mm	
Dim.	Min.	Тур.	Max.
А	4.40		4.60
b	0.61		0.88
b1	1.14		1.70
С	0.48		0.70
D	15.25		15.75
D1		1.27	
E	10		10.40
е	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13		14
L1	3.50		3.93
L20		16.40	
L30		28.90	
ØР	3.75		3.85
Q	2.65		2.95

Table 8.TO-220 type A mechanical data









5 Revision history

Table 9.Document revision history

Date	Revision	Changes
24-Jul-2012	1	First release.



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